Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	2	10/736327	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/15 11:36
S2	1680626	(((printed adj circuit PC wiring) adj (board card module)) pcb PWB motherboard mother adj board carrier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 20:46
S3	1973	capacitor near3 embedd\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT;	OR	ON	2006/03/14 21:35
S4 .	37513	foil near2 copper	IBM_TDB US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 20:57
S5	39431	foil near2 (copper nickel)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 20:58
S6	39449	foil near2 (copper nickel nickel adj alloy)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/14 21:32
S7	816	crystall\$5 near dielectric	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 21:07
S8	144807	electrode near (first second)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 21:07
\$9 -	33	barrier near2 (anti-oxidation anti adj oxidation)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2006/03/10 10:22

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S10	523	layer near2 (anti-oxidation anti adj oxidation)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 21:11
S11	0	S5 same S7 same S8 same S9	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR [*]	ON	2006/03/07 21:09
S12	0	S5 same S7 same S8 same S10	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 21:09
S13	0	S5 and S7 and S8 and S10	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 21:10
S14	. 0	S6 and S7 and S8 and S10	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 21:10
S15	0	S6 and S7 and S10	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 21:11
S16	3912	(anti-oxidation anti adj oxidation)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/14 21:24
S17	1	S6 and S7 and S16	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 21:17
S18	1690805	pzt plzt pczt plt pt pz pmn bto bsto	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/08 11:35
S19		S6 and S18 and S16	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 21:19

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S21	3	S6 and S18 and S16 and S3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/15 10:08
S23	730	S2 and S3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 21:32
S24	1073	capacitor near embedd\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 21:33
S25	479	S2 and S24	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 21:33 .
S26	131	S25 and S6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/08 08:02
S27	3	S26 and S16	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 21:33
S28	40	S26 and S18	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 21:34
S29	3	S28 and S16	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 21:34
\$33	3	S25 and S16	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/07 21:49
S34	2638	S7 S16	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/07 21:49
S35	9	S26 and S34	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/08 07:36

S36	0	"6819540,pn."	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/08 07:37
S37	. 1	"6819540".pn.	US-PGPUB; USPAT; USOCR	OR .	OFF	2006/03/08 07:37
S38	1483	438/381,652.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON ·	2006/03/14 19:24
S39	0	257/635,750	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/08 08:39
S40	1073	capacitor near embedd\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/14 21:08
S41	1	("6410379").URPN.	USPAT	OR	OFF	2006/03/08 08:19
S42	6	("5313094" "5340754" "5561073" "5795811" "6074954" "6146970").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/08 08:19
S43	1916	438/381,393,652.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/08 08:38
S45	. 199 	361/301.1.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR ·	ON	2006/03/08 08:38
S46	1796	257/635,750.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/08 08:39
S47	62134	361/306,306.1,311,-313,321.1, 302-305.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	. 2006/03/08 08:42

 C40	2500	420/210 701 ede:	LIC DCDLID.	OB	ON	2006/02/09 09:42
S49 ·	3500	428/210,701.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/08 08:42
S50	1	S46 and S40	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/08 08:43
S51	349	S40 and "257"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/08 08:45
S52	1796	S46 and "257"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/08 08:44
S53	218	S40 and "361"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/08 08:45
S54	31	S40 and "428"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/08 08:45
S55 ·	. 151	S40 and "438"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/08 08:45
S56	1680626	(((printed adj circuit PC wiring) adj (board card module)) pcb PWB motherboard mother adj board carrier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/08 08:51
S57	131	S40 near6 S56	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/08 08:51
S58	2	("6693793").URPN.	USPAT	OR	OFF	2006/03/08 11:04

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S59	6175	(pzt plzt pczt plt pt pz pmn bto bsto) with dielectric	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/08 11:35
S60	16	S57 and S59	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/08 11:35
S61	14	("20030113443" "5027253" "52611 53" "5796587" "6005777" "6407929 " "6541137").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/09 22:13
S62	1681994	(((printed adj circuit PC wiring) adj (board card module)) pcb PWB motherboard mother adj board carrier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/09 22:14
S63	10	S61 and S62	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/09 22:15
. S64	0	S63 and (anti-oxidation anti adjoxidation)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR ·	ON	2006/03/09 22:14
S65	1976	capacitor near3 embedd\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/15 11:37
\$66	7	S63 and S65	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/10 09:14
S67	4	10/682557	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/10 09:20
S68	6	croswell-robert-t.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/10 10:19

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S69	1413	copper with oxidant\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/10 10:21
S70	1681994	(((printed adj circuit PC wiring) adj (board card module)) pcb PWB motherboard mother adj board carrier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR ·	ON	2006/03/10 10:20
S71	33	S69 with S70	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/10 10:20
S72	37	S70 with (anti-oxidation anti adj oxidation)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/10 11:43
S73	1487	438/381,652.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/14 19:24
S74	1	("6673668").URPN.	USPAT	OR	OFF	2006/03/14 20:56
S75		("5886368" "5926740" "5985730" "6015917" "6031263" "6057628" "6127277" "6144060" "6166401" "6576528").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/14 20:57
S76	1	("6475892").URPN.	USPAT	OR	OFF	2006/03/14 20:59
S77	. 4	("5710067" "5846859" "6130102" "6218292").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/14 20:59
S78	1077	capacitor near embedd\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2006/03/14 21:08
S79	9883	(anti-oxidation anti adj oxidation) nickel-phosphorus nickel adj phosphorus ((sputtering electroless adj plating electrlytic adj plating) near (palladium platinum iridium nickel))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/14 21:31

\$80	39519	foil near2 (copper nickel nickel adj alloy)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/14 21:32
S81	71	S79 with S80	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR -	ON	2006/03/14 21:32
S82 _	1980	capacitor near3 embedd\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/14 21:35
S83	6	S81 and S82	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/14 21:35
S84	0	("6781506").URPN.	USPAT	OR	OFF	2006/03/14 21:45
S85	0	("6781506").URPN.	USPAT	OR	OFF	2006/03/14 21:45
S86	7	("20030048172" "5243320" "5679230" "6372113" "6489035" "6569543" "6610417").PN.	US-PGPUB; USPAT; USOCR	OR.	OFF	2006/03/14 21:55
S87	. 1	"6541137".pn.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/14 21:55
S88	9883	(anti-oxidation anti adj oxidation) nickel-phosphorus nickel adj phosphorus ((sputtering electroless adj plating electrlytic adj plating) near (palladium platinum iridium nickel))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/15 07:20
S89	39519	foil near2 (copper nickel nickel adj alloy)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/15 07:20
S90	71	S88 with S89	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/15 07:29
S91 _.	13	S90 and capacitor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/15 07:30

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L7	0	capactor near embed\$3 and foil and electrode and anti-oxidation and crystalliz\$5 and seclect\$5 near remov\$3.clm.	US-PGPUB	OR	OFF	2006/03/15 09:35
L8	0	capactor and embed\$3 and foil and electrode and anti-oxidation and crystalliz\$5 and seclect\$5 near remov\$3.clm.	US-PGPUB	OR	OFF	2006/03/15 09:21
L9	0	capactor and embed\$3 and foil and electrode and anti-oxidation and crystalliz\$5 and seclect\$5 and remov\$3.clm.	US-PGPUB	OR ,	OFF	2006/03/15 09:21
L10	· O	capacitor and embed\$3 and foil and electrode and anti-oxidation and crystalliz\$5 and seclect\$5 and remov\$3.clm.	US-PGPUB	OR	OFF	2006/03/15 09:22
L11	0	capacitor and foil and electrode and anti-oxidation and crystalliz\$5 and seclect\$5 and remov\$3.clm.	US-PGPUB	OR .	OFF	2006/03/15 09:23
L12	0	capacitor and foil and electrode and anti-oxidation and crystalliz\$5 and seclect\$5 and (remov\$3 etch\$3). clm.	US-PGPUB	OR	OFF	2006/03/15 09:26
L13	0	capacitors and foil and electrode and anti-oxidation and crystalliz\$5 and seclect\$5 and (remov\$3 etch\$3).clm.	US-PGPUB	OR .	OFF	2006/03/15 09:26
L14	0	capacitors and foil and electrode and anti-oxidation and crystalliz\$5 and seclect\$5 and (remov\$3 etch\$3).clm.	US-PGPUB	OR	ON	2006/03/15 09:26
L15	0	capacitors and foil and electrode and barrier and crystalliz\$5 and seclect\$5 and (remov\$3 etch\$3). clm.	US-PGPUB	OR	ON	2006/03/15 09:34
L16	49	capacitors and foil and electrode and barrier and crystalliz\$5 and (remov\$3 etch\$3).clm.	US-PGPUB	OR	ON	2006/03/15 09:35
L17	0	capactor near embed\$3 and foil and electrode and anti-oxidation and crystalliz\$5 and remov\$3.clm.	US-PGPUB	OR	OFF	2006/03/15 09:35

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